

**In the Specification:**

Please add a new section directly before the "Technical Field" as follows:

**CROSS REFERENCE TO RELATED APPLICATION**

This application is a divisional application of United States Patent Application No. 09/644,766 entitled "STACKED MICROELECTRONIC DIES AND METHODS FOR STACKING MICROELECTRONIC DIES," filed on August 23, 2000, now Patent No. \_\_\_\_\_, which is incorporated herein by reference in its entirety.